



N+P-Channel Advanced Power MOSFET

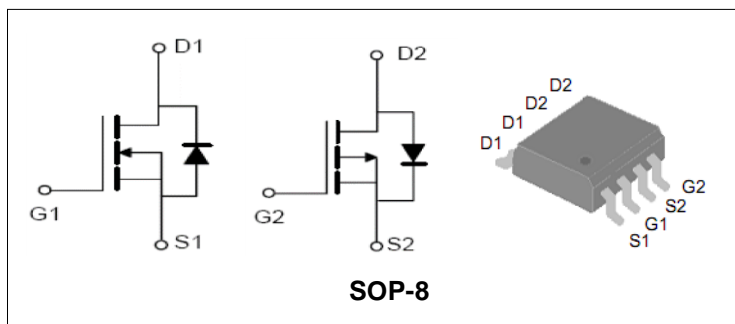
Features

- Improved dv/dt Capability, High Ruggedness
- Maximum Junction Temperature Range (150°C)

Applications

- PWM applications
- Load switch
- Power management

N-Channel		
BVDSS	40	V
ID	8	A
RDSON@VGS=10V	14	mΩ
RDSON@VGS=5V	18	mΩ



P-Channel		
BVDSS	-40	V
ID	-7	A
RDSON@VGS=-10V	27	mΩ
RDSON@VGS=-5V	33	mΩ

Order Information

Product	Package	Marking	Reel Size	Reel	Carton
PTS4614	SOP-8	PTS4614	13inch	3000PCS	48000PCS

Absolute Maximum Ratings

Symbol	Parameter		N-Channel	P-Channel	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)					
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage		40	-40	V
V_{GS}	Gate-Source Voltage		±20	±20	V
T_J	Maximum Junction Temperature		150	150	°C
T_{STG}	Storage Temperature Range		-55 to 150	-55 to 150	°C
I_S	Diode Continuous Forward Current	TA =25°C	8	-7	A
Mounted on Large Heat Sink					
I_{DM}	Pulse Drain Current Tested (Silicon Limit) (Note1)	TA =25°C	32	-28	A
I_D	Continuous Drain current	TA =25°C	8	-7.5	A
P_D	Maximum Power Dissipation	TA =25°C	2		W
$R_{θJA}$	Thermal Resistance Junction-to-Ambient (Note2)		62.5		°C/W



N+P-Channel Advanced Power MOSFET

N-Channel Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain- Source Breakdown Voltage	VGS=0V ID=250μA	40	--	--	V
I _{DSS}	Zero Gate Voltage Drain current	VDS=40V,VGS=0V	--	--	1	μA
I _{GSS}	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.0	2.0	3.0	V
R _{DS(ON)}	Drain-Source On-State Resistance (Note3)	VGS=10V, ID=7A	--	14	20	mΩ
		VGS=5V, ID=3.5A	--	18	30	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note4)						
C _{iss}	Input Capacitance	VDS=20V, VGS=0V, F=1MHz	--	450	--	pF
C _{oss}	Output Capacitance		--	105	--	pF
C _{rss}	Reverse Transfer Capacitance		--	10	--	pF
Q _g	Total Gate Charge	VDS= 20V, ID= 4A, VGS=4.5V	--	12.5	--	nC
Q _{gs}	Gate-Source Charge		--	3.3	--	nC
Q _{gd}	Gate-Drain Charge		--	3.2	--	nC
Switching Characteristics (Note4)						
t _{d(on)}	Turn-on Delay Time	VDD=20V, ID=3A, R _G =3.3Ω, VGS=10V	--	5	--	nS
t _r	Turn-on Rise Time		--	3.2	--	nS
t _{d(off)}	Turn-off Delay Time		--	15	--	nS
t _f	Turn-off Fall Time		--	2.1	--	nS
Source- Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage (Note3)	IS=4A,VGS=0V	--	0.82	1.2	V



N+P-Channel Advanced Power MOSFET

P-Channel Electrical Characteristics

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain- Source Breakdown Voltage	VGS=0V ID=-250μA	-40	--	--	V
I _{DSS}	Zero Gate Voltage Drain current	VDS=-40V,VGS=0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	VDS=VGS,ID=-250μA	-1	-2.0	-3.0	V
R _{DS(ON)}	Drain-Source On-State Resistance (Note5)	VGS=-10V, ID=-7A	--	27	35	mΩ
		VGS=-5V, ID=-3A	--	33	45	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) (Note4)						
C _{iss}	Input Capacitance	VDS= -20V,	--	550	--	pF
C _{oss}	Output Capacitance	VGS=0V,	--	110	--	pF
C _{rss}	Reverse Transfer Capacitance	F=1MHz	--	55	--	pF
Q _g	Total Gate Charge	VDS= -20V,	--	13	--	nC
Q _{gs}	Gate-Source Charge	ID= -3A,	--	4	--	nC
Q _{gd}	Gate-Drain Charge	VGS= -4.5V	--	3	--	nC
Switching Characteristics (Note6)						
t _{d(on)}	Turn-on Delay Time	VDD=-20V,	--	8	--	nS
t _r	Turn-on Rise Time	ID=-6A,	--	5	--	nS
t _{d(off)}	Turn-off Delay Time	RG=3.3Ω,	--	22	--	nS
t _f	Turn-off Fall Time	VGS=-4.5V	--	8.5	--	nS
Source- Drain Diode Characteristics @ T_J = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage (Note5)	IS=-4A,VGS=0V	--	-0.83	-1.2	V

Note:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec
3. Pulse Test: pulse width ≤ 300 us, duty cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.



N+P-Channel Advanced Power MOSFET

Typical Characteristics(N-Channel)

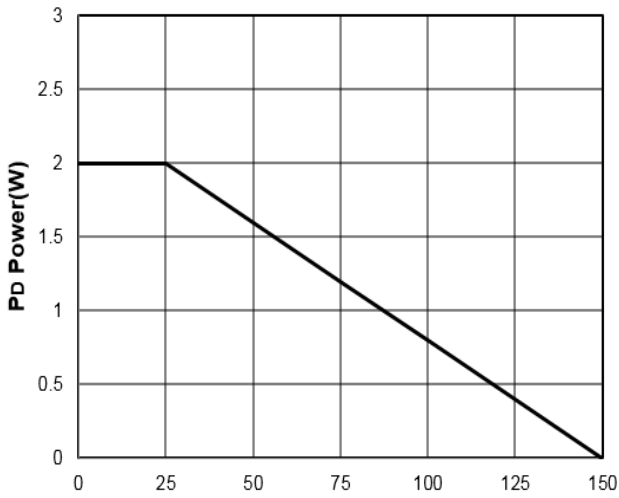


Figure1: Tj Junction Temperature (°C)

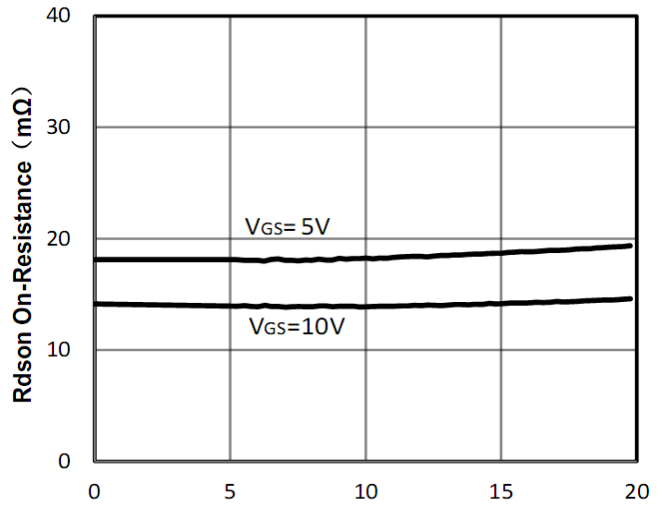


Figure2: Id Drain Current (A)

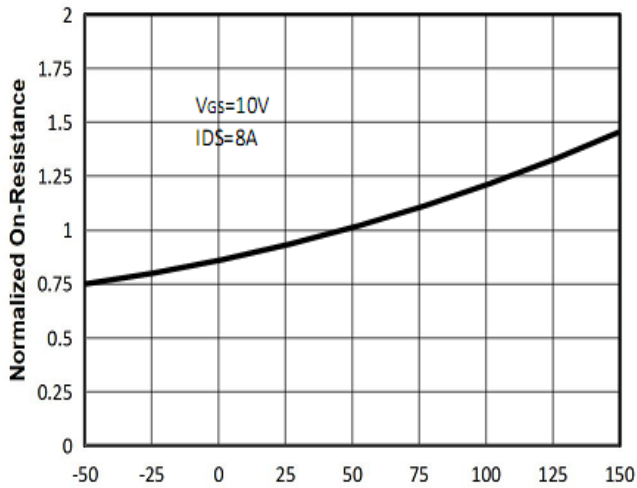


Figure3 : Tj Junction Temperature (°C)

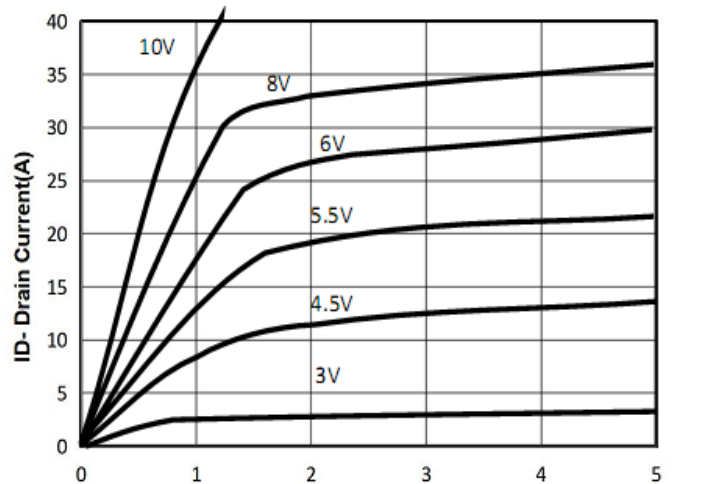


Figure4 : Vds Drain-Source Voltage (V)

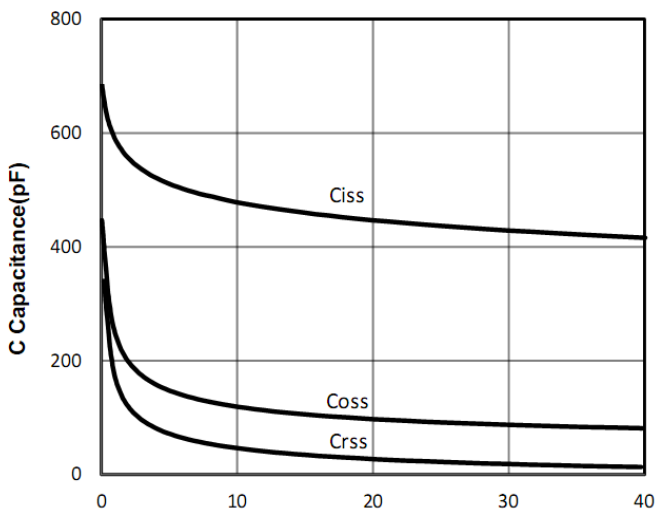


Figure5: Vds Drain-Source Voltage (V)

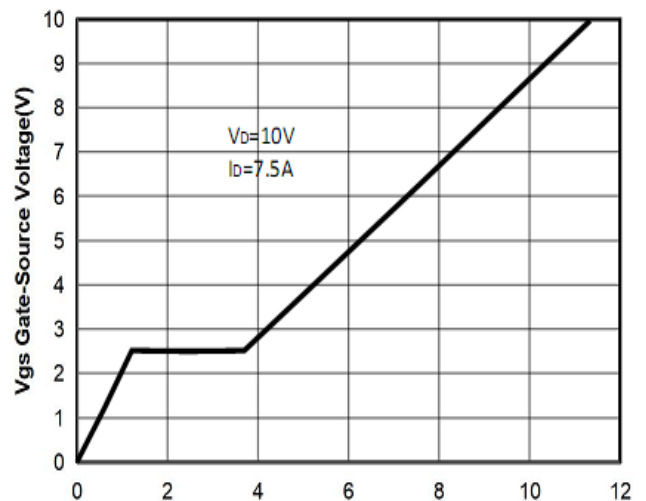


Figure6: Qg Gate Charge (nC)



N+P-Channel Advanced Power MOSFET

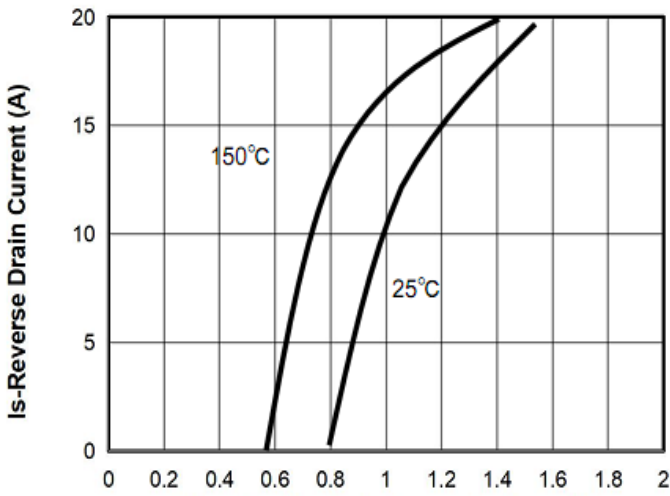


Figure7: Vsd Source-Drain Voltage (V)

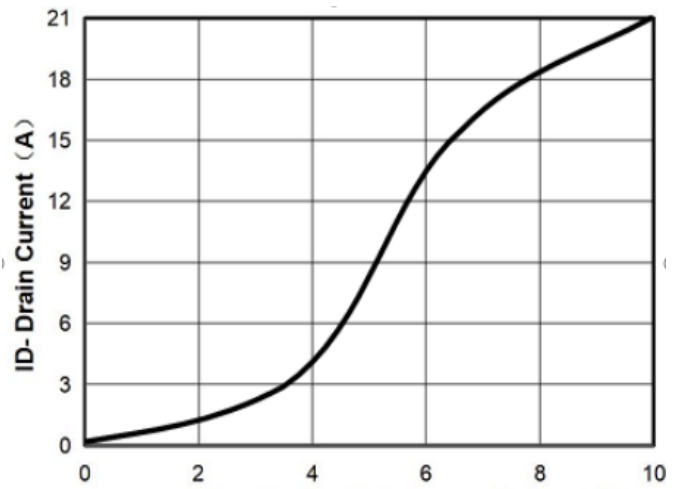


Figure8: Vgs Gate-Source Voltage (V)

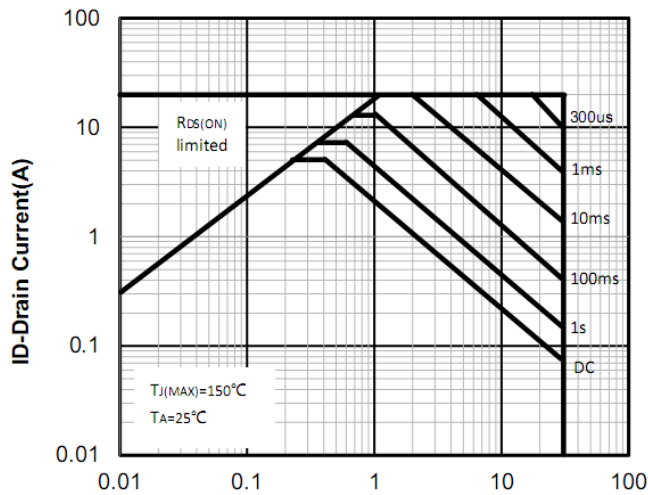


Figure9: Vds Drain -Source Voltage (V)

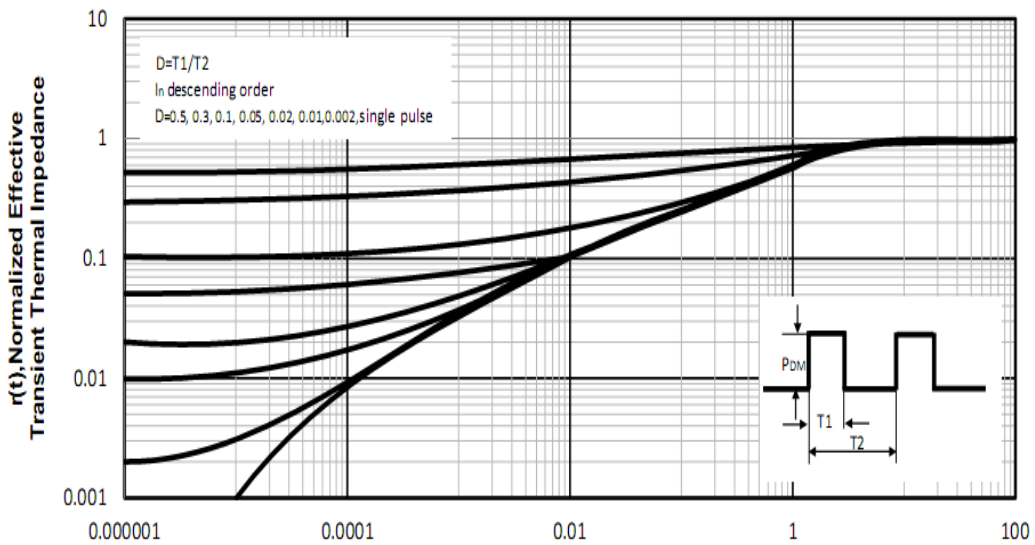


Figure10: Square Wave Pulse Duration (sec)

N+P-Channel Advanced Power MOSFET

Test Circuit and Waveform(N-Channel):

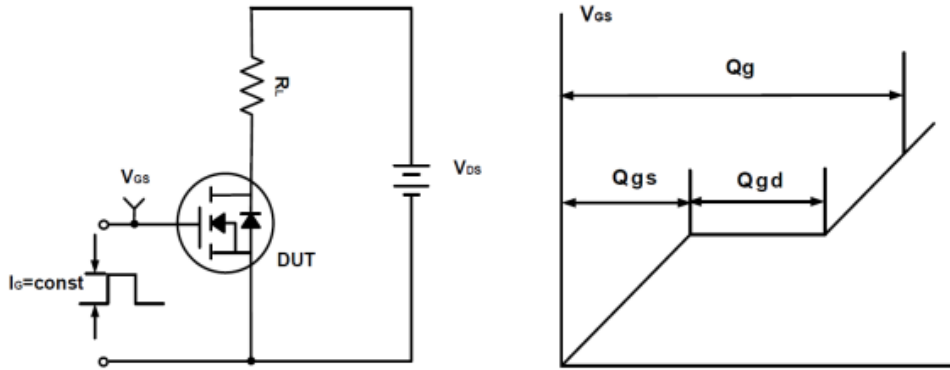


Figure A Gate Charge Test Circuit & Waveforms

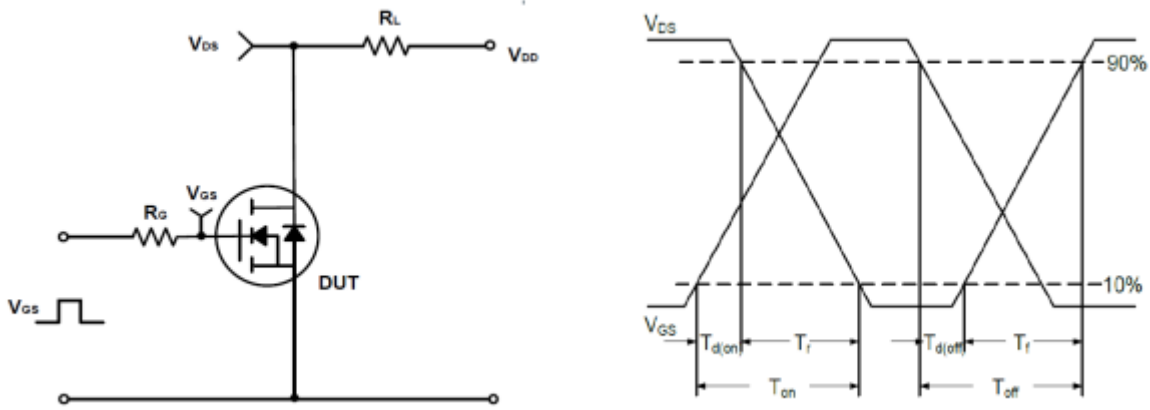


Figure B Switching Test Circuit & Waveforms

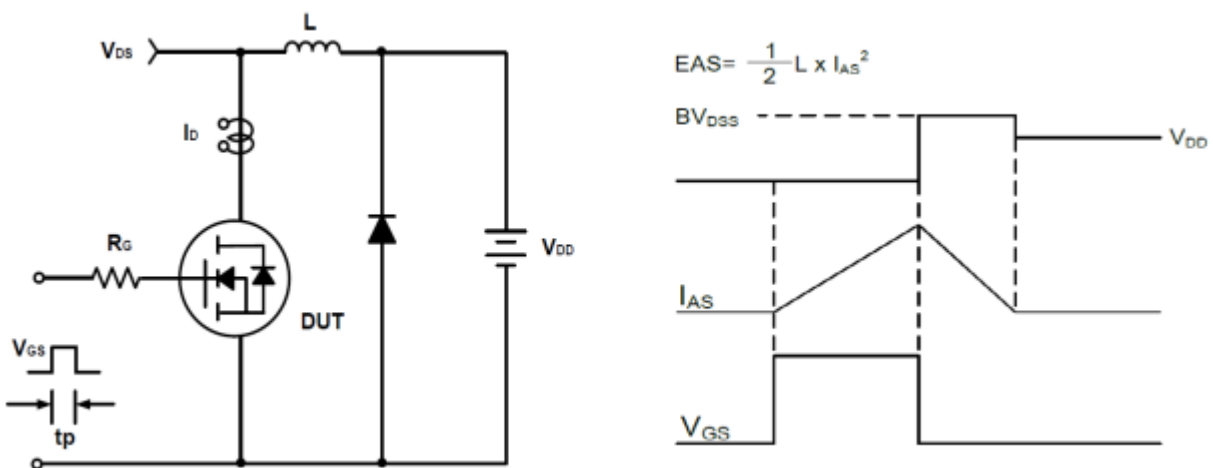


Figure C Unclamped Inductive Switching Circuit & Waveforms

Typical Characteristics(P-Channel)



N+P-Channel Advanced Power MOSFET

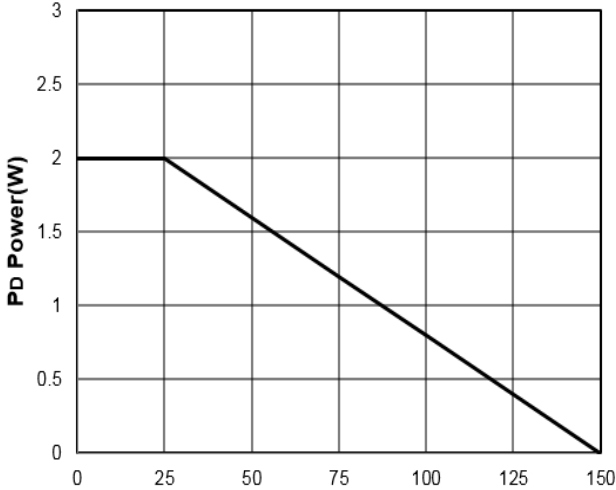


Figure11: Tj Junction Temperature (°C)

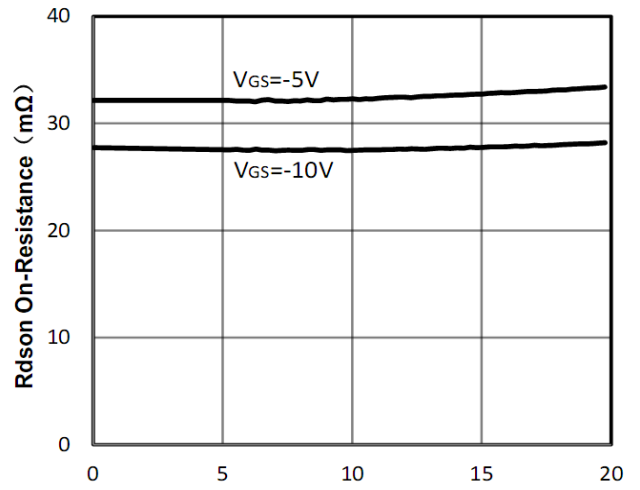


Figure12: -Id Drain Current (A)

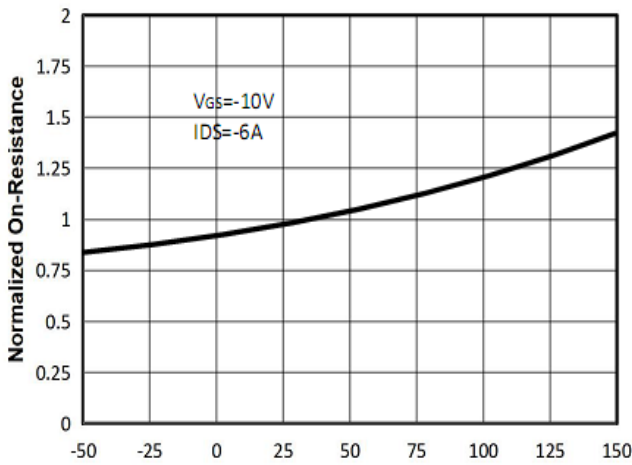


Figure13: Tj Junction Temperature (°C)

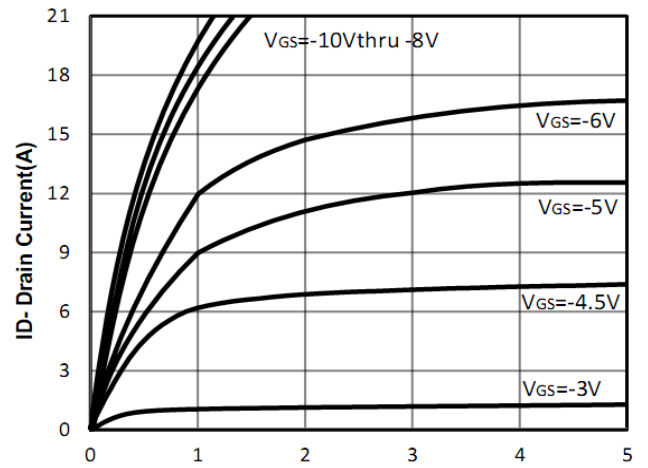


Figure14: -Vds Drain-Source Voltage (V)

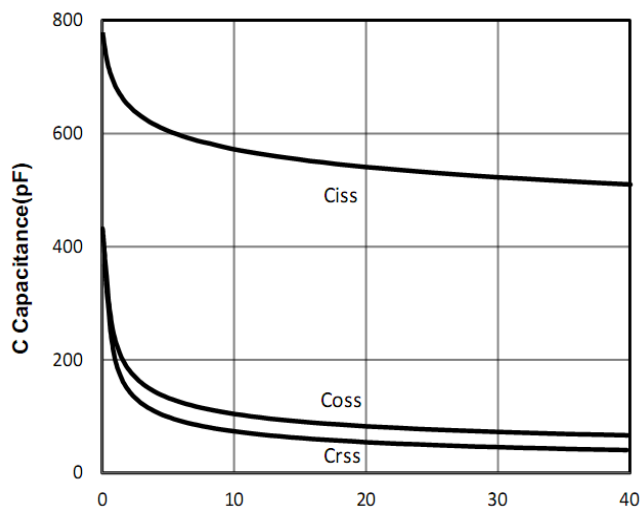


Figure15: -Vds Drain-Source Voltage (V)

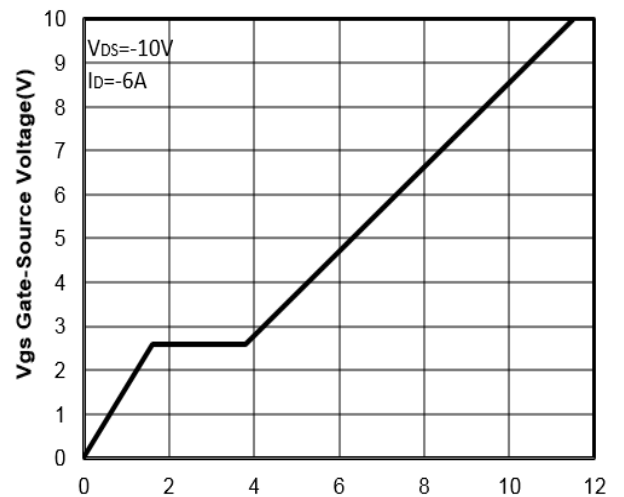


Figure16: Qg Gate Charge (nC)



N+P-Channel Advanced Power MOSFET

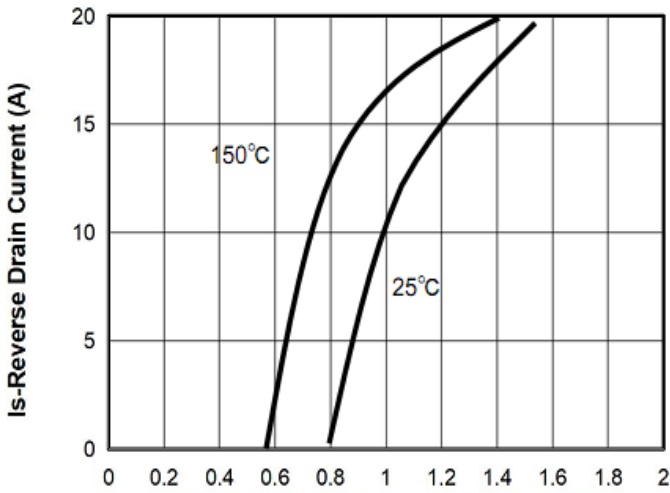


Figure17: Vsd Source-Drain Voltage (V)

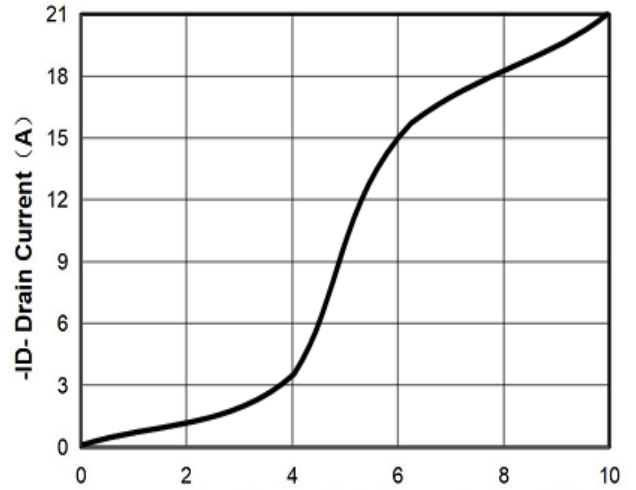


Figure18: -Vgs Gate-Source Voltage (V)

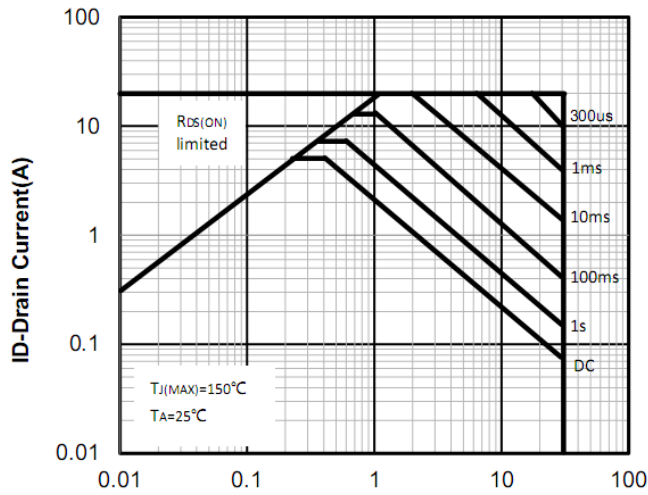


Figure19: Vds Drain -Source Voltage (V)

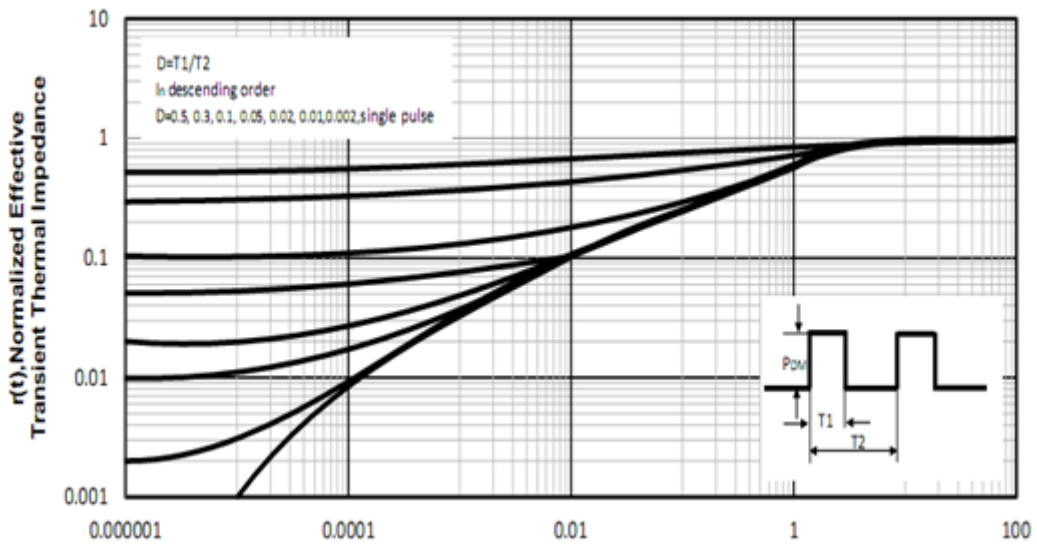


Figure20: Square Wave Pulse Duration (sec)

N+P-Channel Advanced Power MOSFET

Test Circuit and Waveform(P-Channel):

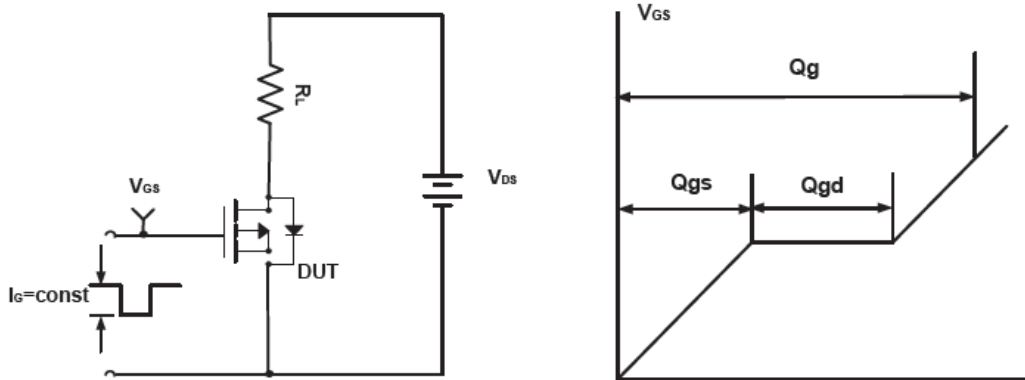


Figure D Gate Charge Test Circuit & Waveforms

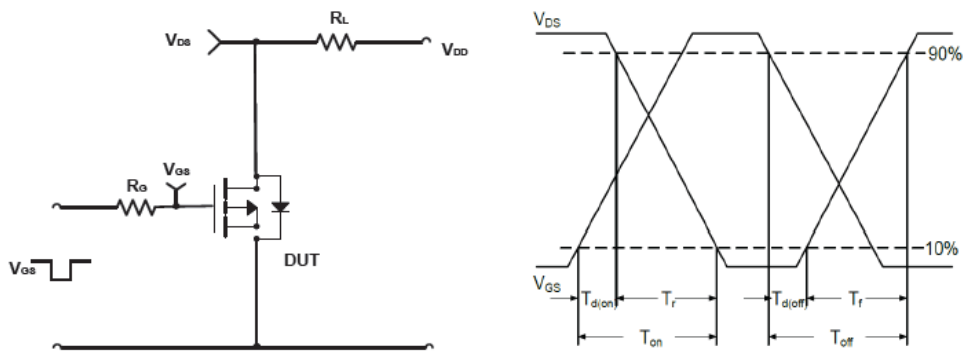


Figure E Switching Test Circuit & Waveforms

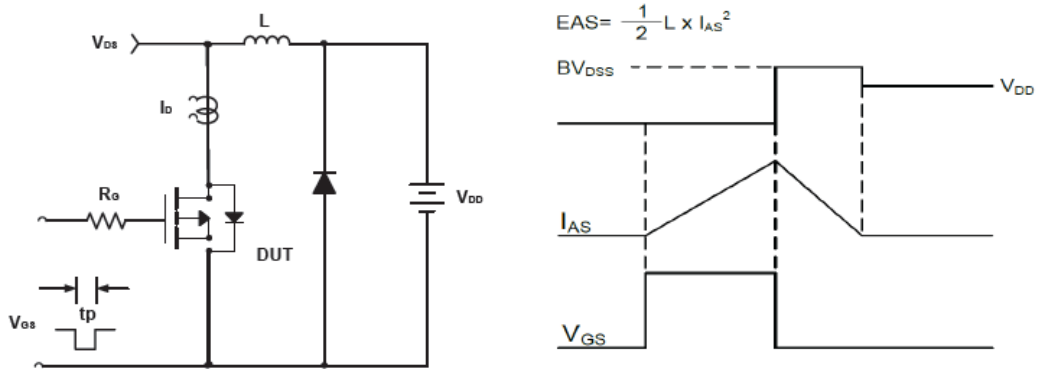
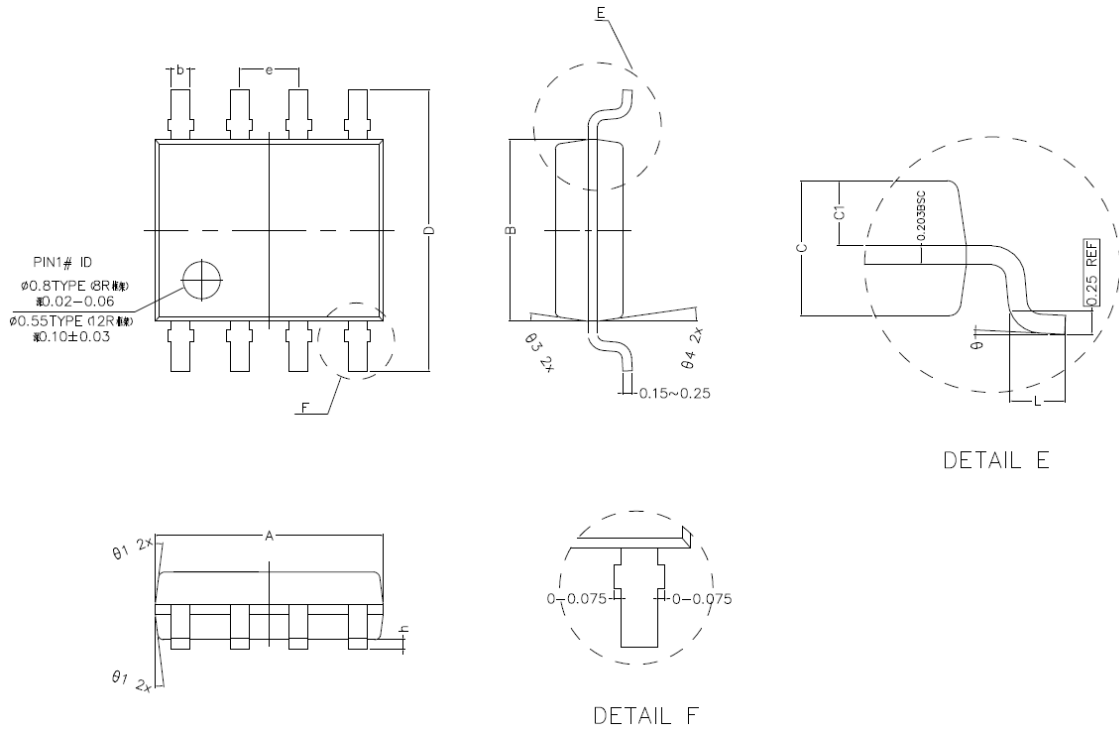


Figure F Unclamped Inductive Switching Circuit & Waveforms

N+P-Channel Advanced Power MOSFET
SOP-8 Package Outline Dimensions (Units: mm)


COMMON DIMENSIONS (UNITS OF MEASURE IS mm)			
	MIN	NORMAL	MAX
A	4.800	4.900	5.000
B	3.800	3.900	4.000
C	1.350	1.450	1.550
C1	0.650	0.700	0.750
D	5.900	6.100	6.300
L	0.500	0.600	0.700
b	0.350	0.400	0.450
h	0.050	0.150	0.250
e	1.270TYPE		
θ_1	7° TYPE(8R)		12° TYPE(12R)
θ_2	7° TYPE(8R)		10° TYPE(12R)
θ_3	8° TYPE(8R)		12° TYPE(12R)
θ_4	8° TYPE(8R)		10° TYPE(12R)
θ	0° ~ 8°		